



20A, 700V N-CHANNEL POWER MOSFET

Description

The C20N70 is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

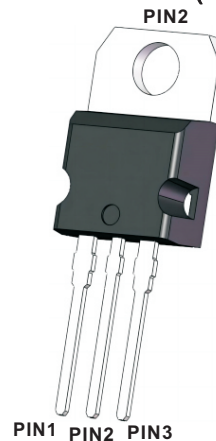
Features

- $R_{DS(ON)} < 0.60\Omega$ @ $V_{GS}=10V$, $I_D=10A$
- Fast switching capability
- Avalanche energy tested
- Improved dv/dt capability, high ruggedness

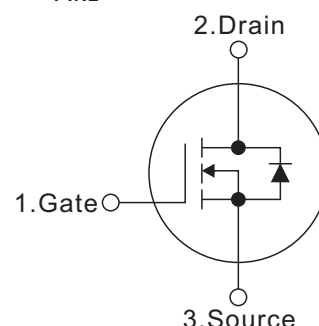
Mechanical data

- Case: TO-220-3L
- Approx. Weight: 2.04g (0.072oz)
- Lead free finish, RoHS compliant
- Case Material: "Green" molding compound, UL flammability classification 94V-0, "Halogen-free".

TO-220-3L(*Prefix :C)



ROHS
COMPLIANT



Packing Marking And Ordering Information

Device Package	Device	Marking	Packing Type	QTY Per Tube	Inner box	Per Carton
TO-220-3L	C20N70	C20N70	Tube	50 Pcs	2,500 Pcs	5,000 Pcs

Absolute Maximum Ratings (Ta=25°C, Unless Otherwise Specified)

Parameter	Symbols	Ratings	Units
Drain-Source Voltage	V_{DSS}	700	V
Gate-Source Voltage	V_{GSS}	±30	V
Continuous Drain Current $T_c=25^\circ C$ $T_c=100^\circ C$	I_D	20 12.5	A
Pulsed Drain Current (Note 2)	I_{DM}	80	A
Avalanche Energy Single Pulsed (Note 3)	E_{AS}	500	mJ
Power Dissipation ($T_c = 25^\circ C$)	P_D	45	W
Operating junction and storage temperature	T_J, T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH, IAS = 10A, VDD = 50V, RG = 25 Ω, Starting TJ = 25°C

Thermal Resistance

Parameter	Symbols	Ratings	Units
Thermal resistance, junction – case.	R_{thJC}	2.77	°C/W
Thermal resistance, junction – ambient(min. footprint)	R_{thJA}	63	°C/W



Electrical Characteristics (Ta=25°C, Unless Otherwise Specified)

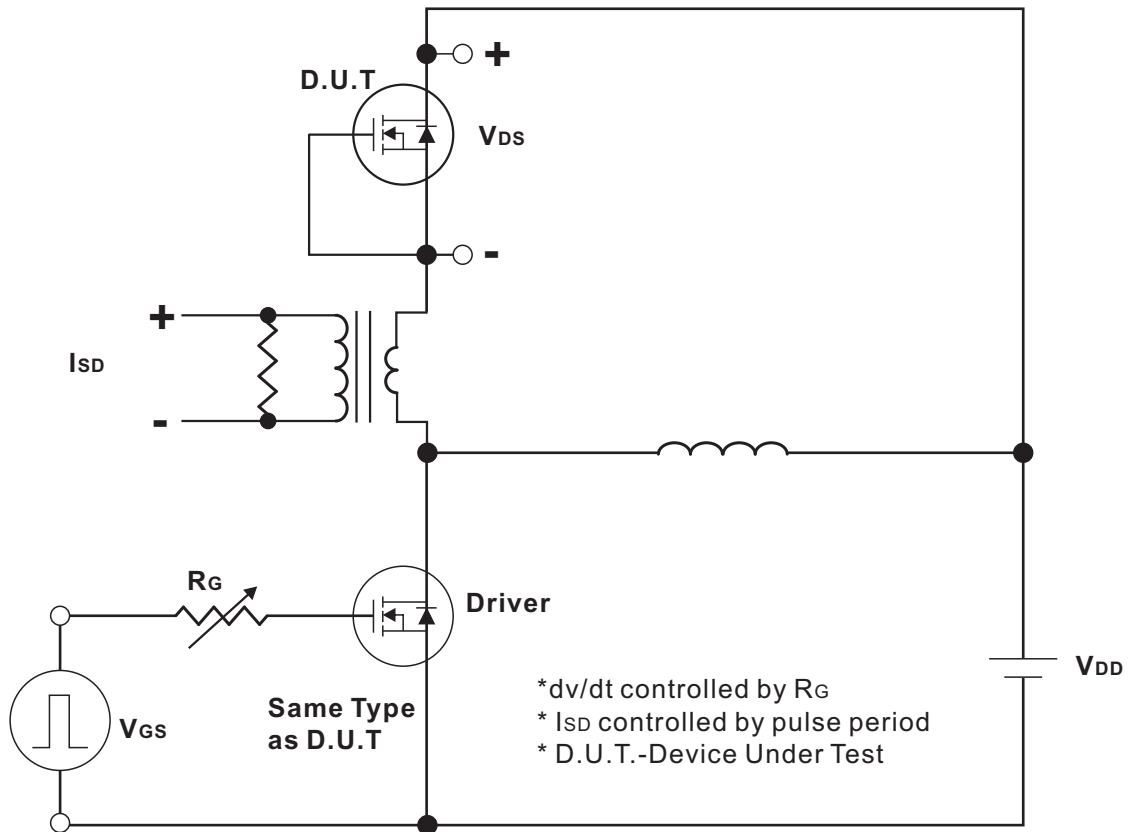
Parameter	Symbols	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	700			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=700V, V_{GS}=0V$			1.0	μA
Gate- Source Leakage Current	Forward	I_{GSS}			100	nA
	Reverse				-100	
On Characteristics						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=10A$		0.40	0.60	Ω
Transconductance	g_{fs}	$V_{DS}=15V, I_D=10A$		14		S
Dynamic Characteristics						
Input Capacitance	C_{ISS}	$V_{DS}=25V,$ $V_{GS}=0V,$ $f=1.0MHz$		3352		pF
Output Capacitance	C_{OSS}			239		pF
Reverse Transfer Capacitance	C_{RSS}			8.5		pF
Gate resistance	R_G			2.0		Ω
Switching Characteristics						
Total Gate Charge (Note 1)	Q_G	$V_{DS}=560V, V_{GS}=10V,$ $I_D=20A, I_G=1mA$ (NOTE1,2)		70		nC
Gate-Source Charge	Q_{GS}			18		nC
Gate-Drain Charge	Q_{GD}			23		nC
Turn-On Delay Time (Note 1)	$t_{D(ON)}$	$V_{DS}=100V, I_D=20A$ $R_G=25\Omega, V_{GS}=10V$ (NOTE1,2)		40		ns
Turn-On Rise Time	t_R			30		ns
Turn-Off Delay Time	$t_{D(OFF)}$			210		ns
Turn-Off Fall Time	t_F			56		ns
Drain-Source Diode Characteristics And Maximum Ratings						
Maximum Body-Diode Continuous Current	I_S				20	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$I_{SD}=20A, V_{GS}=0V$			1.4	V
Reverse Recovery Time (Note 1)	t_{rr}	$I_F=20A$ $di/dt=100A/\mu s$		508		ns
Reverse Recovery Charge	Q_{rr}			9.6		μC

Notes:

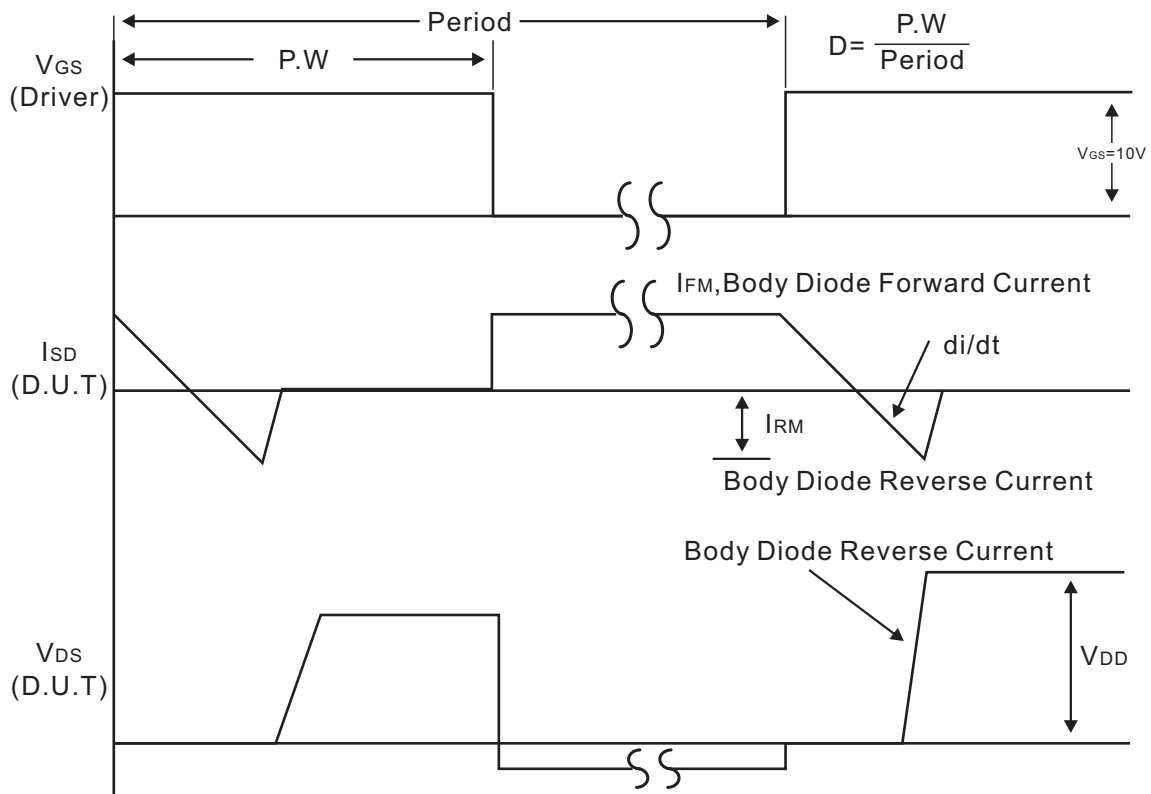
1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.
2. Essentially independent of operating temperature.



Test Circuits and waveforms



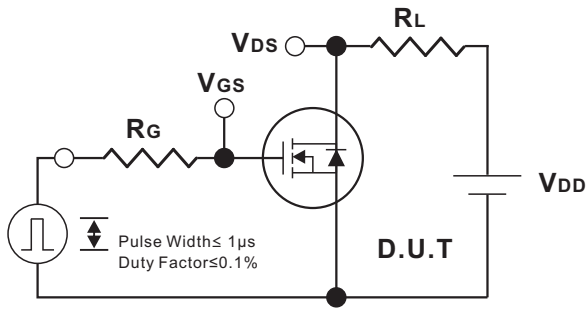
Peak Diode Recovery dv/dt Test Circuit



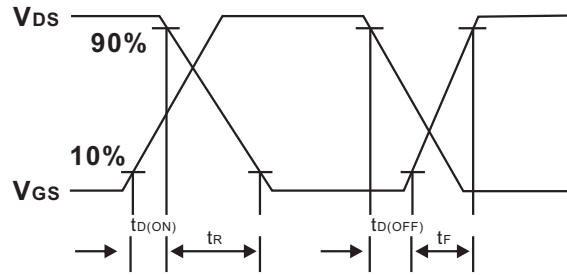
Body Diode Forward Voltage Drop
Peak Diode Recovery dv/dt Waveforms



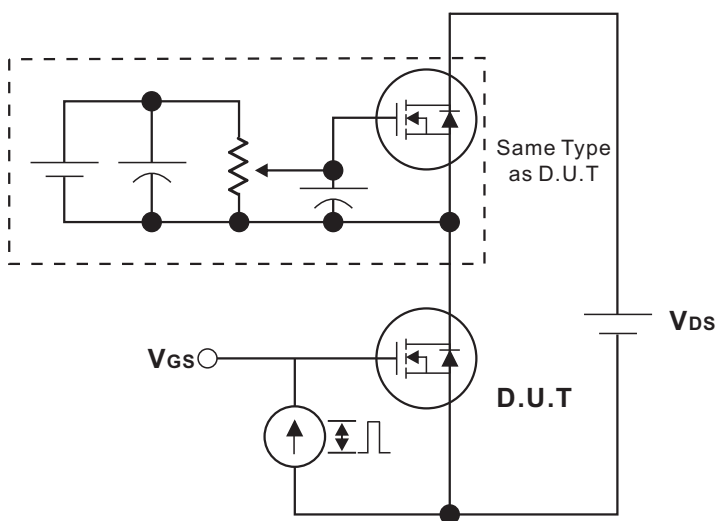
Test Circuits and waveforms



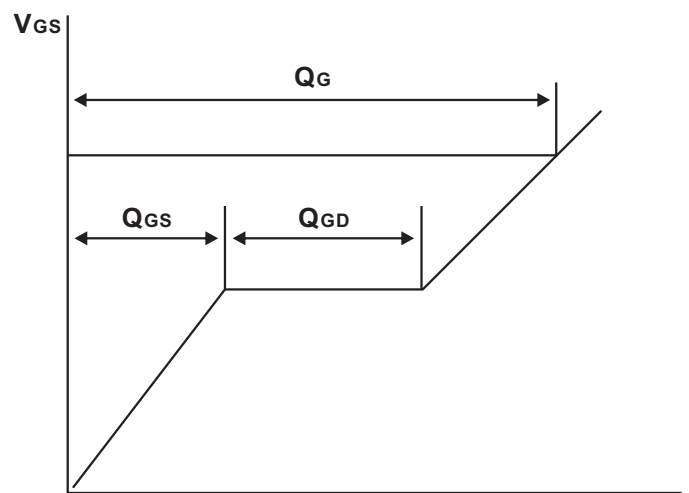
Switching Test Circuit



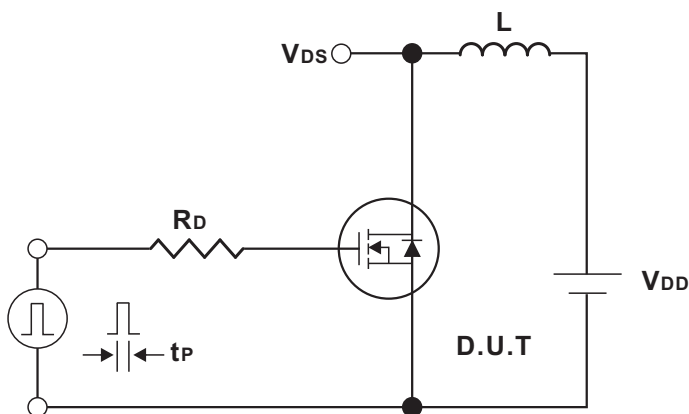
Switching Waveforms



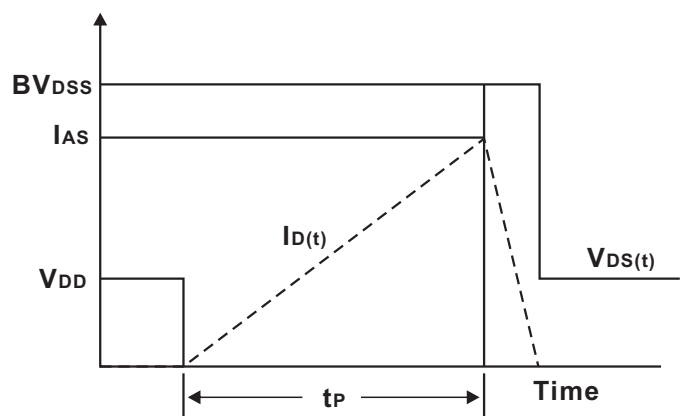
Gate Charge Test Circuit



Charge
Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



Typical Characteristics

Fig.1 Output characteristics

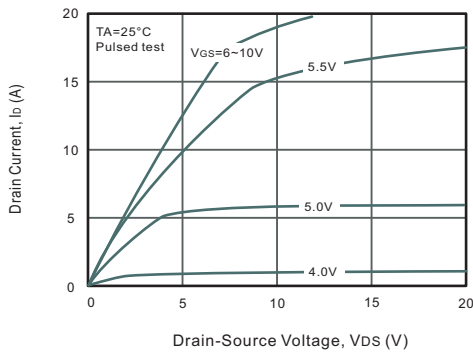


Fig.2 Power Dissipation

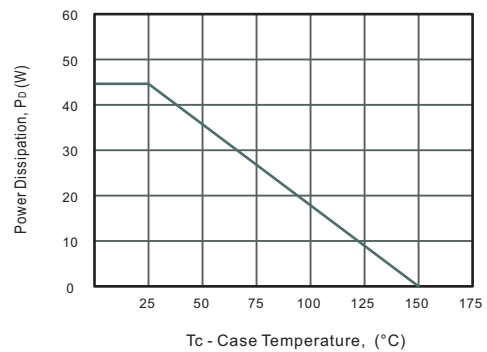


Fig.3 Drain Current Derating

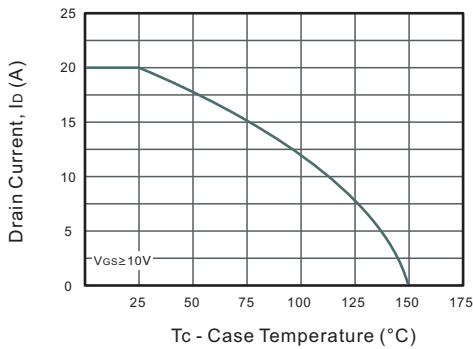


Fig.4 Drain-Source On-Resistance vs. Drain Current

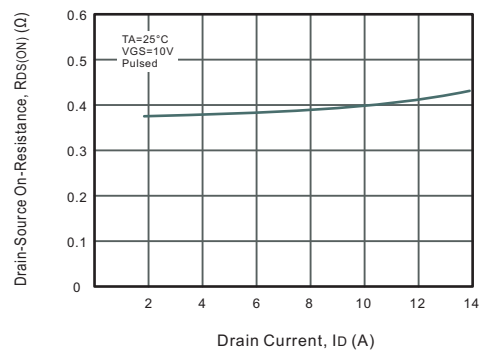


Fig.5 Gate Threshold Voltage vs. Junction Temperature

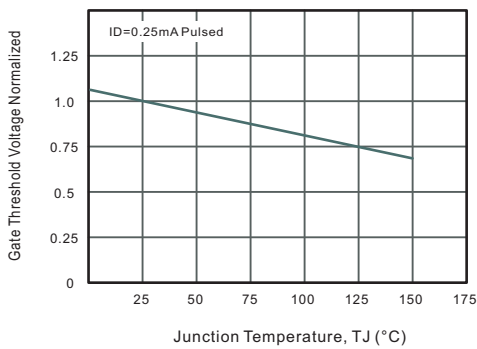


Fig.6 Body-diode Forward Characteristics

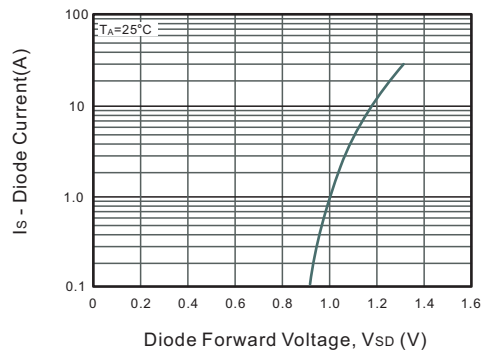


Fig.7 Drain-Source On-Resistance vs. Junction Temperature

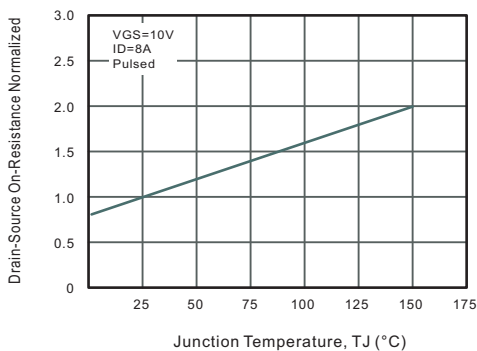
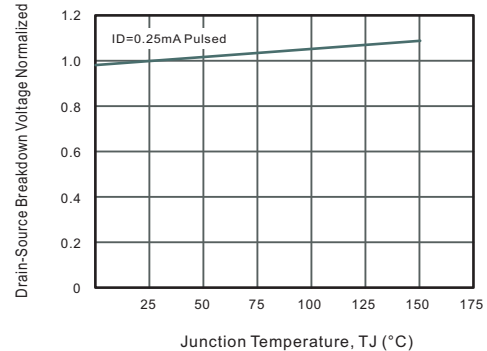


Fig.8 Breakdown Voltage vs. Junction Temperature





Typical Characteristics

Fig.9 Capacitance Characteristics

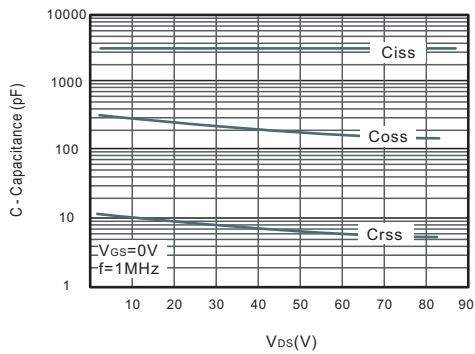


Fig.10 Gate Charge Characteristics

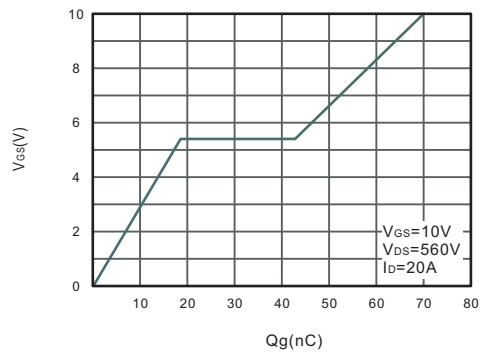


Fig.11 Safe Operating Area

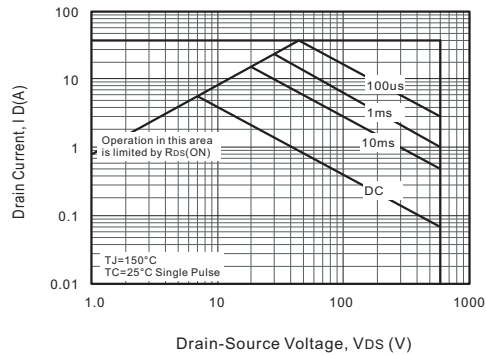
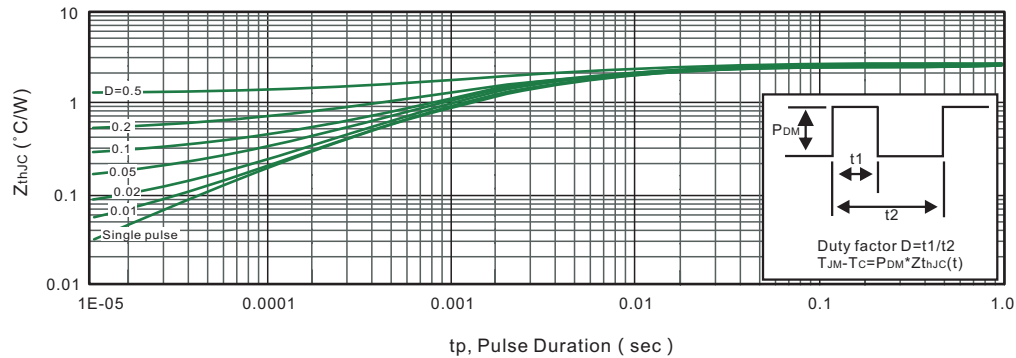


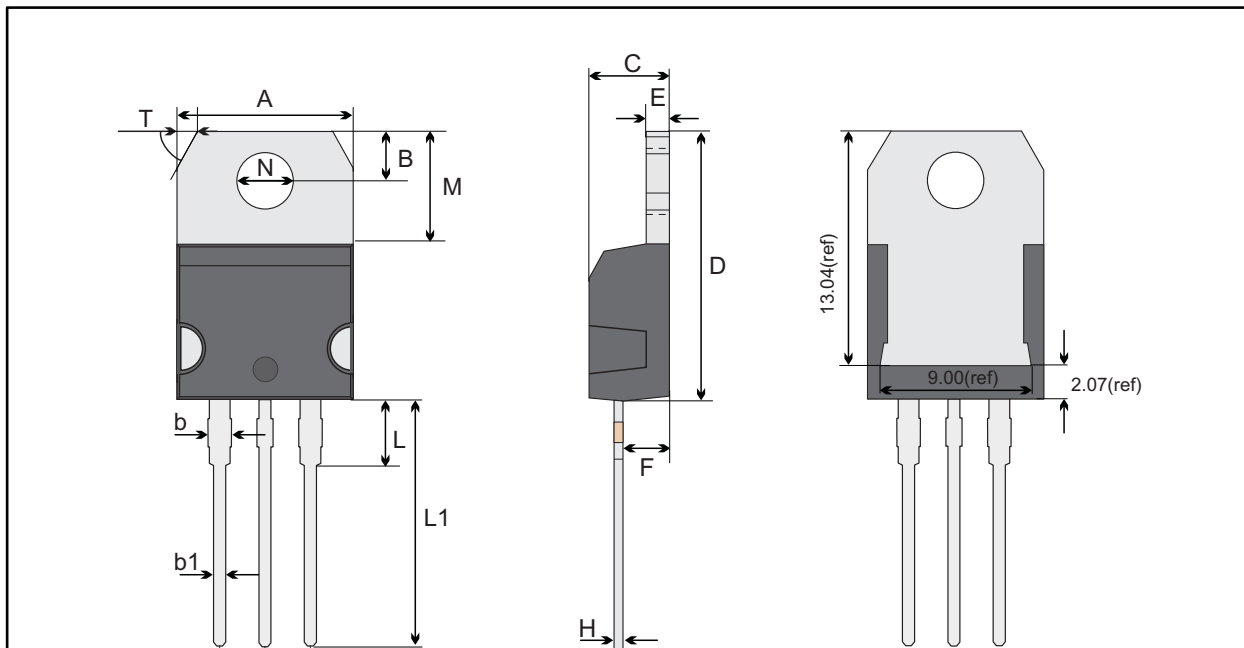
Fig.12 Max. Transient Thermal Impedance





Package Outline
Through Hole Package ; 3 leads

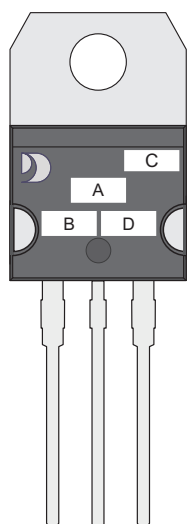
TO-220-3L



TO-220-3L mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N	T
mm	max	10.28	2.84	1.67	0.9	4.65	15.54	1.37	2.79	2.64	0.6	3.88	13.13	6.39	3.82 typ.	1.19 58° ref.
	typ	10.18	2.74	1.47	0.8	4.45	15.34	1.27	2.59	2.54	0.5	3.68	12.93	6.19		
	min	10.08	2.64	1.27	0.7	4.25	15.14	1.17	2.39	2.44	0.4	3.48	12.73	5.99		
mil	max	405	112	66	35	183	612	54	110	104	24	153	517	252	150 typ.	47 58° ref.
	typ	401	108	58	31	175	604	50	102	100	20	145	509	244		
	min	397	104	50	28	167	596	46	94	92	16	137	501	236		

Marking Diagram



- Unmarkable Surfacea
- Marking Composition Field
- a: Ejector Pin Mark
- A: Marking Area
- B: Lot Code
- C: Additional Information
- D: Date Code (YWW)
- Y: Years(0~9)
- WW: Week



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